



#### Dimensions

Footprint	7343
L	7.3mm +/-0.3mm
W	4.3mm +/-0.3mm
H	2.8mm +/-0.3mm
S	1.3mm +/-0.3mm
F	2.4mm +/-0.1mm
K	1.8mm TYP

#### Packaging Specifications

Packaging	T&R, 330mm
Packaging Quantity	2800

#### General Information

Series	B45196P
Dielectric	MnO <sub>2</sub> Tantalum
Style	SMD Chip
Description	SMD, Molded, High Temperature
Features	High Temperature, Automotive
RoHS	Yes
Termination	Tin
Qualifications	AEC-Q200
AEC-Q200	Yes
Notes	Obsolete.

#### Specifications

Capacitance	6.8 uF
Capacitance Tolerance	20%
Voltage DC	50 VDC (85C), 39.85 VDC (125C), 33.5 VDC (150C)
Temperature Range	-55/+150°C
Rated Temperature	85°C
Dissipation Factor	6%
Failure Rate	N/A
Resistance	0.7 Ohms (100kHz)
Ripple Current	462.9 mAmps (25C), 416.6 mAmps (85C), 185.2 mAmps (125C)
Leakage Current	3.4 uA

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